

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3186037

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the ASSIGNOR'S NAME TO DAVID L. LUCE, JR. previously recorded on Reel 033775 Frame 0714. Assignor(s) hereby confirms the ASSIGNMENT.	
CONVEYING PARTY DATA		
	Name	Execution Date
	DAVID L. LUCE JR.	09/18/2014
RECEIVING PARTY DATA		
Name:	JPMORGAN CHASE BANK, N.A.	
Street Address:	270 PARK AVENUE	
City:	NEW YORK	
State/Country:	NEW YORK	
Postal Code:	10017	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14490943
CORRESPONDENCE DATA		
Fax Number:	(202)778-2201	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	2029551500	
Email:	patdcdoCKET@hunton.com	
Correspondent Name:	HUNTON & WILLIAMS LLP	
Address Line 1:	2200 PENNSYLVANIA AVENUE, NW	
Address Line 2:	INTELLECTUAL PROPERTY DEPARTMENT	
Address Line 4:	WASHINGTON, D.C. 20037	
ATTORNEY DOCKET NUMBER:	72167.000866	
NAME OF SUBMITTER:	TYLER MADDY	
SIGNATURE:	/Tyler Maddy/	
DATE SIGNED:	01/16/2015	
Total Attachments: 4		
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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT3029977

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	DAVID L. LUCE	09/18/2014
RECEIVING PARTY DATA		
Name:	JPMORGAN CHASE BANK, N.A.	
Street Address:	270 PARK AVENUE	
City:	NEW YORK	
State/Country:	NEW YORK	
Postal Code:	10017	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14490943	
CORRESPONDENCE DATA		
Fax Number:	(202)778-2201	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	202-419-2055	
Email:	sloftis@hunton.com	
Correspondent Name:	HUNTON & WILLIAMS LLP	
Address Line 1:	2200 PENNSYLVANIA AVENUE, N.W.	
Address Line 2:	INTELLECTUAL PROPERTY DEPARTMENT	
Address Line 4:	WASHINGTON, D.C. 20037	
ATTORNEY DOCKET NUMBER:	72167.000866	
NAME OF SUBMITTER:	TYLER MADDRY	
SIGNATURE:	/Tyler Maddry/	
DATE SIGNED:	09/19/2014	
Total Attachments: 3		
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ASSIGNMENT

WHEREAS, I, David L. Luce, Jr., residing at **2816 Jeanne Court, Lewis Center, OH 43035**, have invented, developed, and/or have rights in the invention(s) (hereinafter "Invention") entitled:

ENTITLEMENT SYSTEM AND METHOD

described in an application for United States Letters Patent, being executed concurrently herewith, the specification of which is attached hereto (hereinafter "Application"); and

WHEREAS, JPMorgan Chase Bank, N.A., a corporation organized under the laws of the United States of America and having a place of business at 270 Park Avenue, New York, NY 10017 (hereinafter "Assignee"), is desirous of acquiring the entire right, title, and interest in and to the Invention and in and to the Application.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignee and its successors and assigns, my entire right, title and interest, worldwide, in and to the Invention and the Application, and all patents and applications, worldwide, claiming priority to and/or benefit of, directly or indirectly, or based in whole or in part on, said Application and/or said Invention, including continuations, continuations-in-part, divisionals, reissues, reexaminations, renewals, substitutes, and extensions thereof, and any international and regional applications, based in whole or in part on any of the aforesaid applications or in whole or in part on said Invention, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all utility-model registrations, inventor's certificates, and the like heretofore or hereafter filed, worldwide, for the Invention, and in and to any and all patents (including all extensions, renewals, reexaminations and reissues thereof), worldwide, which have been or may be granted on any of the aforesaid applications or on said Invention or any parts thereof.

AND I HEREBY covenant and agree for myself and my heirs, executors and administrators that I will communicate to Assignee any facts known to me respecting the Invention and the aforementioned applications, sign all lawful papers, testify in any legal proceeding, make all rightful oaths, and take any other actions that may be necessary or desirable to secure to Assignee its right, title, and interest in and to the aforementioned patents, applications and Invention, and generally do everything possible to aid Assignee to obtain and enforce proper patent protection for the Invention and the aforementioned patents and applications;

AND I HEREBY agree to execute without further consideration any further documents and instruments which may be necessary, lawful and proper in the prosecution of said applications, or in the preparation or prosecution of any continuation, continuation-in-part, divisional, substitute, renewal, reexamination or reissue application or in any amendments, extensions or interference proceedings, or other applications for patents or similar rights of any region or country, that may be necessary to secure to Assignee its interest and title in and to said Invention or any parts thereof, and in and to said applications and patents;

AND I HEREBY authorize and request my agent, Hunton & Williams LLP, whose address is 2200 Pennsylvania Avenue, N.W., Washington, D.C. 20037, to insert hereon any identification necessary or desirable for recordation of this document, including the filing date and application number of said Application when known;

AND I HEREBY covenant for myself and my legal representatives, and agree with said Assignee, its successors and assigns, that I have the full right to convey the entire interest herein assigned, and that I have granted no right or license to make, use, sell or offer to sell said Invention, to anyone except said Assignee, that prior to the execution of this deed, my right, title and interest in said Invention and said Application had not been otherwise encumbered, and that I have not and will not execute any instrument in conflict therewith;

AND I HEREBY authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty is to issue patents on applications as aforesaid, to issue any and all letters patents which may be granted upon said United States and foreign applications or upon the Invention to the Assignee.

- SIGNATURES BEGIN ON NEXT PAGE -

IN WITNESS WHEREOF, I have executed this Assignment as of the date set forth below.

David L. LUCE, Jr.

Signature: Det L

Printed Name: DAVID L LUCE JR

Date: 18 SEPT 14

WITNESS

Signature: Geoff Novak

Printed Name: Geoff Novak

Date: 9/18/14

WITNESS

Signature: Trisha Almoner

Printed Name: Trisha Almoner

Date: 9/18/14